



# P-DUKE POWER

## DOS06-05T · DOH06-05T Series

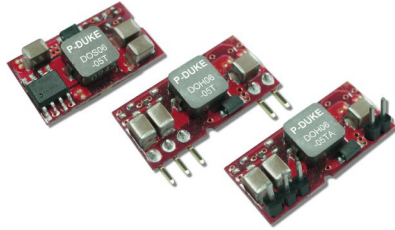
DC-DC Converter  
Up to 6 Amps

# 3

YEARS  
WARRANTY

ROHS  
COMPLIANT

REACH  
COMPLIANT



Automation



Datacom



IPC



Industry



Measurement



Telecom



Automobile



Boat



Charger



Medical



PV



Railway



**NO**  
Min. Load  
Required

REMOTE  
**ON**  
**OFF**

**OCP**

**SCP**

**UVP**

### PART NUMBER STRUCTURE

**DOS06** -

**05**

**T**

-

**P**

Series Name

Input  
Voltage  
(VDC)

Package

Remote Control  
Options

**DOS06:** SMD TYPE  
**DOH06:** SIP TYPE

**05:** 2.4~5.5

SMD TYPE  
SIP TYPE

**T:** No Assembly  
**T:** Vertical Mounting SIP  
**TA:** Horizontal Mounting SIP

**□:** Negative Logic  
**P:** Positive Logic

**TECHNICAL SPECIFICATION** All specifications are typical at nominal input, full load and 25°C unless otherwise noted

Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current Vin(nom) @ No Load 0.75VDC / 3.3VDC	Efficiency Vin(nom),3.3VDC @Full Load	Maximum Capacitor Load ESR ≥ 1mΩ / ESR ≥ 10mΩ
	VDC	VDC	A	mA	%	μF
DOS06-05T						
DOS06-05T-P						
DOH06-05T	2.4 ~ 5.5	0.75 ~ 3.3	6	20 / 45	94	1000 / 3000
DOH06-05T-P	Vin(min.)=Vout(set)+0.5					
DOH06-05TA						
DOH06-05TA-P						

INPUT SPECIFICATIONS						
Parameter	Conditions	Min.	Typ.	Max.	Unit	
Operating input voltage range	Vout(set) < Vin-0.5VDC	2.4	5	5.5	VDC	
Maximum input current	Vin=Vin(min.), Vout(set)=3.3VDC, Io=Io(max.)		6		A	
Start up voltage				2.4	VDC	
Shutdown voltage		1.6	2.0	2.2	VDC	
Input filter	*It is needed to add external input capacitors are required 2pcs of 150μF low-ESR polymer capacitors and 2pcs of 47μF ceramic capacitors in parallel. The capacitors should connect as close as possible to the input terminals that ensuring module stability.				Capacitor type	

OUTPUT SPECIFICATIONS						
Parameter	Conditions	Min.	Typ.	Max.	Unit	
Voltage accuracy	% of Vout(set)	-2.0		+2.0	%	
Line regulation	Vin=Vout(set)+0.5VDC to Vin(max.) at Full Load	-0.3		+0.3	%	
Load regulation	No Load to Full Load	-0.4		+0.4	%	
Voltage adjustability		0.7525		3.63	VDC	
Ripple and noise	Measured by 20MHz bandwidth, with a 1μF MLCC & a 10μF T/C			20	mVrms	
				50	mVp-p	
Temperature regulation	T <sub>A</sub> = -40°C to +85°C	-0.4		+0.4	%	
Dynamic load response	With a 1μF MLCC & a 10μF T/C ΔIo/Δt=2.5A/μs, Vin(nom) Peak deviation 50% load step change Setting time(Vout<10%peak deviation)		130		mV	
			25		μs	
	With 2pcs of 150μF polymer capacitors ΔIo/Δt=2.5A/μs, Vin(nom) Peak deviation 50% load step change Setting time(Vout<10%peak deviation)		50		mV	
			50		μs	
Over load protection	% of Iout rated		220		%	
Short circuit protection			Continuous, automatic recovery			
Output voltage overshoot-startup	Vin=2.4~5.5VDC at Full Load		1.0		%	

GENERAL SPECIFICATIONS						
Parameter	Conditions	Min.	Typ.	Max.	Unit	
Isolation voltage			None			
Switching frequency		270	300	330	kHz	
Safety meets			IEC/ EN/ UL62368-1			
Weight			2.8g (0.1oz)			
MTBF	MIL-HDBK-217F, Full load		9.398 x 10 <sup>6</sup> hrs			

## ENVIRONMENTAL SPECIFICATIONS

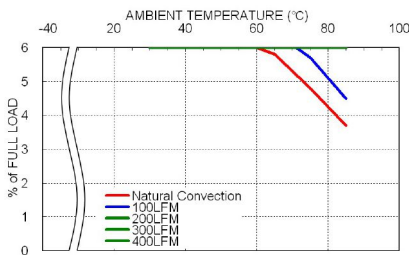
Parameter	Conditions	Min.	Typ.	Max.	Unit
Operating ambient temperature	With derating	-40		+85	°C
Over temperature protection	Controller		135		°C
Storage temperature range		-55		+125	°C
Thermal shock					MIL-STD-810F
Vibration					MIL-STD-810F
Relative humidity(non-condensing)				5% to 95%	RH
Moisture sensitivity level(MSL)	Only for SMD type Verification according to IPC J-STD-020E				IPC J-STD-033C Level 2a
Lead-free reflow solder process	Only for SMD type				The time above 217°C 30~60sec. Peak temperature 245°C max. Time above 240°C 10sec. max.

## FEATURE SPECIFICATIONS

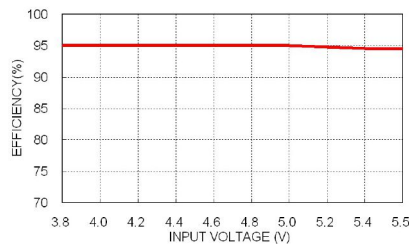
Parameter	Conditions	Min.	Typ.	Max.	Unit
Remote ON/OFF	Referred to GND pin Negative logic DC-DC ON (Standard) Positive logic DC-DC ON (Option) DC-DC OFF DC-DC OFF Input current of Ctrl pin Remote off input current	0.01		1.0	mA
					mA
	*Positive logic:ON/OFF is open collector/drain logic input Negative logic:ON/OFF pin is open collector/drain logic input with external pull-up resistor				
Rise time	Time for Vout to rise from 10% to 90%of Vout(set)			6	ms
Turn-on delay time	Case 1, Case 2  *Case 1: ON/OFF input is set to logic low (module on) and then input power is applied (delay from instant at which Vin=Vin(min.) until Vout=10% of Vout(set))  *Case 2:Input power is applied for at least one second and then the ON/OFF input is set to logic low (delay from instant at which Von/off=0.3VDC until Vout=10% of Vout(set))		1		ms

**CAUTION:** This power module is not internally fused. An input line fuse must always be used.

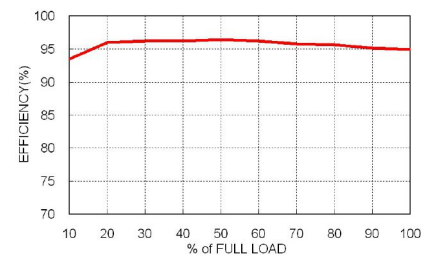
## CHARACTERISTIC CURVE



DOS06-05T, Vout=3.3V  
Derating Curve



DOS06-05T, Vout=3.3V  
Efficiency vs. Input Voltage



DOS06-05T, Vout=3.3V  
Efficiency vs. Output Load

## FUSE CONSIDERATION

This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture.

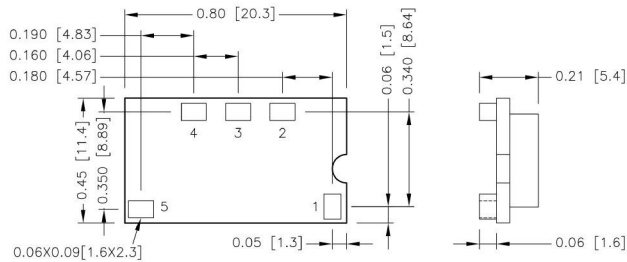
To maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The input line fuse suggest as below :

Model	Fuse Rating (A)	Fuse Type
DOS06-05T□□□□	8	Fast-Acting
DOH06-05T□□□□	8	Fast-Acting

The table based on the information provided in this data sheet on inrush energy and maximum DC input current at low Vin.

## MECHANICAL DRAWING

### DOS06-05T

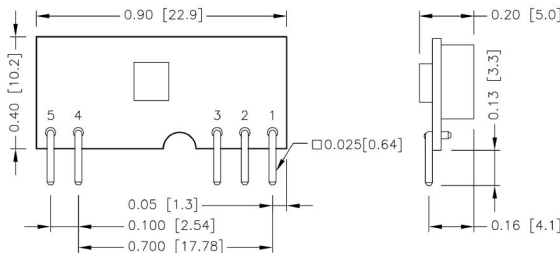


BOTTOM VIEW

### PIN CONNECTION

PIN	DEFINE
1	Ctrl
2	+Vout
3	Trim
4	GND
5	+Vin

### DOH06-05T

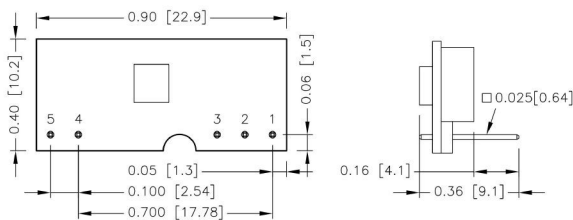


BOTTOM VIEW

### PIN CONNECTION

PIN	DEFINE
1	+Vout
2	Trim
3	GND
4	+Vin
5	Ctrl

### DOH06-05TA



BOTTOM VIEW

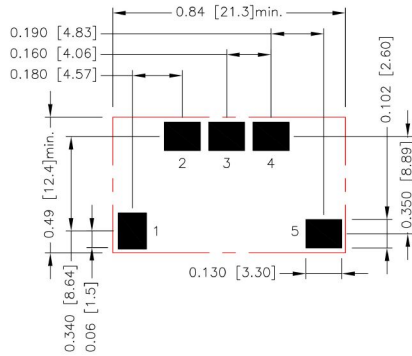
### PIN CONNECTION

PIN	DEFINE
1	+Vout
2	Trim
3	GND
4	+Vin
5	Ctrl

- All dimensions in inch [mm]
- Tolerance :x.xx±0.02 [x.x±0.5]  
x.xxx±0.01 [x.xx±0.25]
- Pin dimension tolerance ±0.004[0.10]

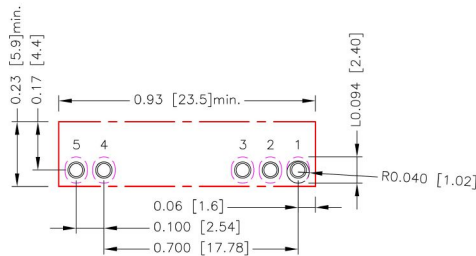
**RECOMMENDED PAD LAYOUT**

**DOS06-05T**



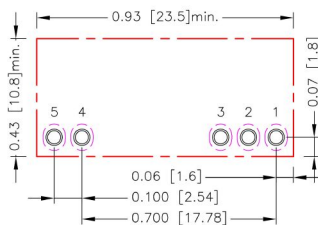
All dimensions in inch[mm]  
Pad size(lead free recommended)  
Top view pad 1.2.3.4.5: 0.130x0.102[3.30x2.60]

**DOH06-05T**



All dimensions in inch[mm]  
Pad size(lead free recommended)  
Through hole 1.2.3.4.5:  $\Phi$ 0.047[1.20]  
Top view pad 1.2.3.4.5:  $\Phi$ 0.059[1.50]  
Bottom view pad 1.2.3.4.5:  
Groove R0.040[1.02]L-0.094[2.40]

**DOH06-05TA**



All dimensions in inch[mm]  
Pad size(lead free recommended)  
Through hole 1.2.3.4.5:  $\Phi$ 0.047[1.20]  
Top view pad 1.2.3.4.5:  $\Phi$ 0.059[1.50]  
Bottom view pad 1.2.3.4.5:  
Groove R0.040[1.02]L-0.094[2.40]

## THERMAL CONSIDERATIONS

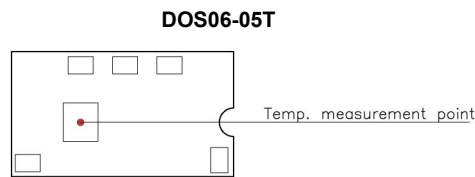
The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as the figure below.

The temperature at this location should not exceed 125°C.

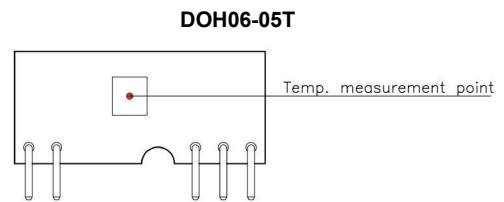
When operating, adequate cooling must be provided to maintain the test point temperature at or below 125°C.

Although the maximum point temperature of the power modules is 125°C, you can limit this temperature to a lower value for extremely high reliability.

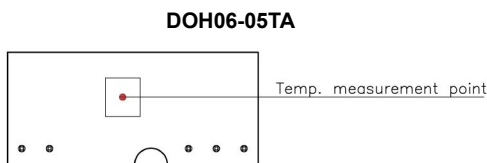
- Thermal test condition with vertical direction by natural convection (20LFM).



BOTTOM VIEW



BOTTOM VIEW

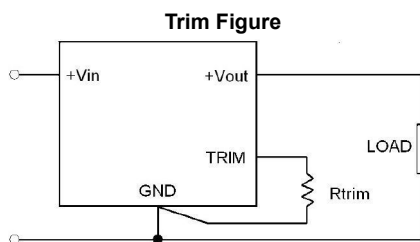


BOTTOM VIEW

## OUTPUT VOLTAGE PROGRAMMING

Output voltage programmable from 0.75V to 3.3V by connecting a single resistor (shown as Trim Table) between the Trim and GND pins of the module. To calculate the value of the resistor Rtrim for a particular output voltage Vout, use the following equation:

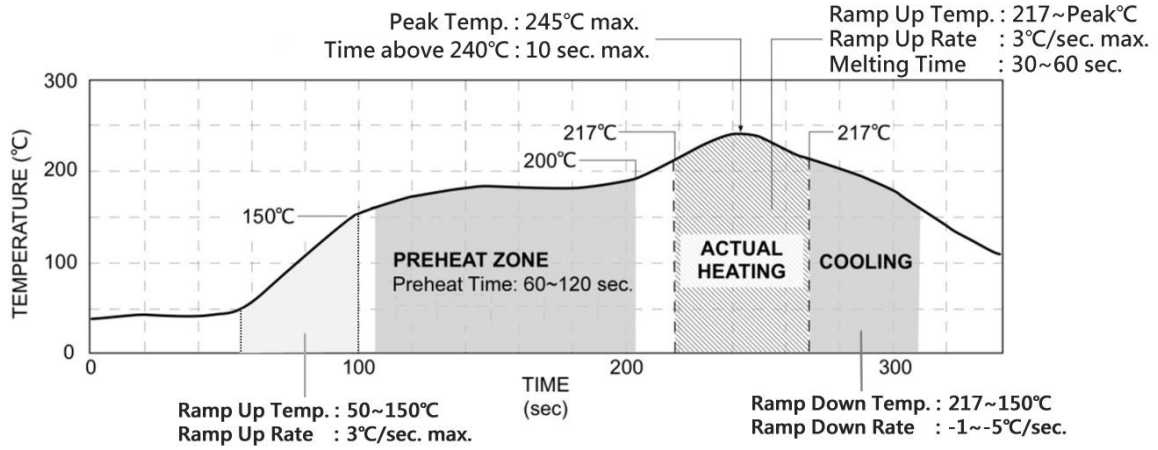
■ **Rtrim Equation** : 
$$R_{trim} = \left[ \frac{21070}{V_{out} - 0.7525} - 5110 \right] \Omega$$



**Trim Table**

Vout(set) (VDC)	Rtrim (kΩ)
0.7525	Open
1.2	41.973
1.5	23.077
1.8	15.004
2.5	6.974
3.3	3.160

**LEAD FREE REFLOW PROFILE For SMD Type**



\*The curves define the maximum peak reflow temperature permissible measured on pin1 or Vin pin.